

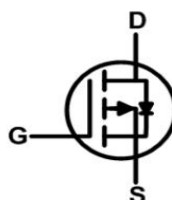


GENERAL DESCRIPTION

The RZC6103D is the high cell density trench P-Channel MOSFET, which provide excellent $R_{DS(ON)}$ and gate charge for most of the synchronous buck converter applications.

The RZC6103D meet the RoHS and Green Product requirement with full function reliability approved.

PIN CONFIGURATION



FEATURES

- -60V/-18A, $R_{DS(ON)} = 65m\Omega$ $V_{GS} = 10V$ (TYP.)
- -60V/-18A, $R_{DS(ON)} = 95m\Omega$ $V_{GS} = 4.5V$ (TYP.)
- 100% EAS Guaranteed
- Green Device Available
- Supper Low Gate Charge
- Excellent Cdv/dt effect decline
- Advanced high cell density Trench technology
- TO-252 package design

APPLICTIONS

- Load Switch
- Battery Powered System
- Hard Switch and High Frequency Circuits
- UPS.

ORDERING INFORMATION

Part Number	Package	Top Marking	Packing
RZC6103D	TO-252	D6103	2500PCS/Tape&Real

**MAXIMUM RATINGS** (Ta = 25°C)

Parameter	Symbol		Value	Units
Drain to Source Voltage	V _{DSS}		-60	V
Gate to Source Voltage	V _{GSS}		±20	V
Continuous Drain Current	25°C	I _D	-18	A
	70°C		-11	A
Pulsed Drain Current (note 1)	I _{D(pulse)}		-36	A
Single Pulse Avalanche Energy	E _{AS}		35	mJ
Avalanche Current	I _{AS}		-26	A
Maximum Power Dissipation	25°C	P _D	34.7	W
Thermal Resistance,Junction to Case	R _{ΘJC}		62	°C/W
Thermal Resistance,Junction to Ambient	R _{ΘJA}		3.6	°C/W
Operating Junction Temperature	T _J		150	°C
Storage Temperature	T _{STG}		-55-+150	°C
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)	T _L		260	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

**ELECTRICAL CHARACTERISTICS** ($T_A = 25^\circ\text{C}$)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX	Units
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_{DS}=-250\mu A$	-60			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-48V, V_{GS}=0V$ $T_J=25^\circ\text{C}$			-1	μA
		$V_{DS}=-48V, V_{GS}=0V$ $T_J=55^\circ\text{C}$			-5	μA
Gate Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
Gate threshold voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS},$ $I_D=-250\mu A$	-1.2	-2	-2.5	V
Drain to Source On-state Resistance ^(note 2)	$R_{DS(ON)}$	$V_{GS}=-10V, I_D=-12A$		65	70	m Ω
		$V_{GS}=-4.5V, I_D=-8A$		95	105	m Ω
Input Capacitance	C_{ISS}	$V_{DS}=-15V,$ $V_{GS}=0V, f=1\text{MHz}$		1447		pF
Output Capacitance	C_{OSS}			97		pF
Reverse Transfer Capacitance	C_{RSS}			70		pF
Total Gate Charge (-4.5V)	Q_G	$V_{DD}=-48V,$ $V_{GS}=-10V, I_D=-10A$		9.86		nC
Gate-Source Charge	Q_{GS}			3.08		nC
Gate-Drain Charge	Q_{GD}			2.95		nC
Turn-On Delay Time	$T_{d(on)}$	$V_{DD}=-15V,$ $V_{GS}=-10V$ $R_G=3.3\Omega, I_D=-1A$		28.8		nS
Rise Time	T_r			19.8		
Turn-Off Delay Time	$T_{d(off)}$			60.8		
Fall Time	T_f			7.2		
Drain-Source Diode Forward Voltage	V_{SD}	$I_S=-1A, V_{GS}=0V,$ $T_C=25^\circ\text{C}$		-0.9	-1.2	V
Maximum Continuous Drain-Source Diode Forward Current	I_D	$T_C=25^\circ\text{C}$			-18	A
Maximum Pulse Drain-Source Diode Forward Current	I_{DSM}				-36	A

Note : 1.The data tested by surface mounted on a 1 inch²FR-4 board with 20Z copper.

2.The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$

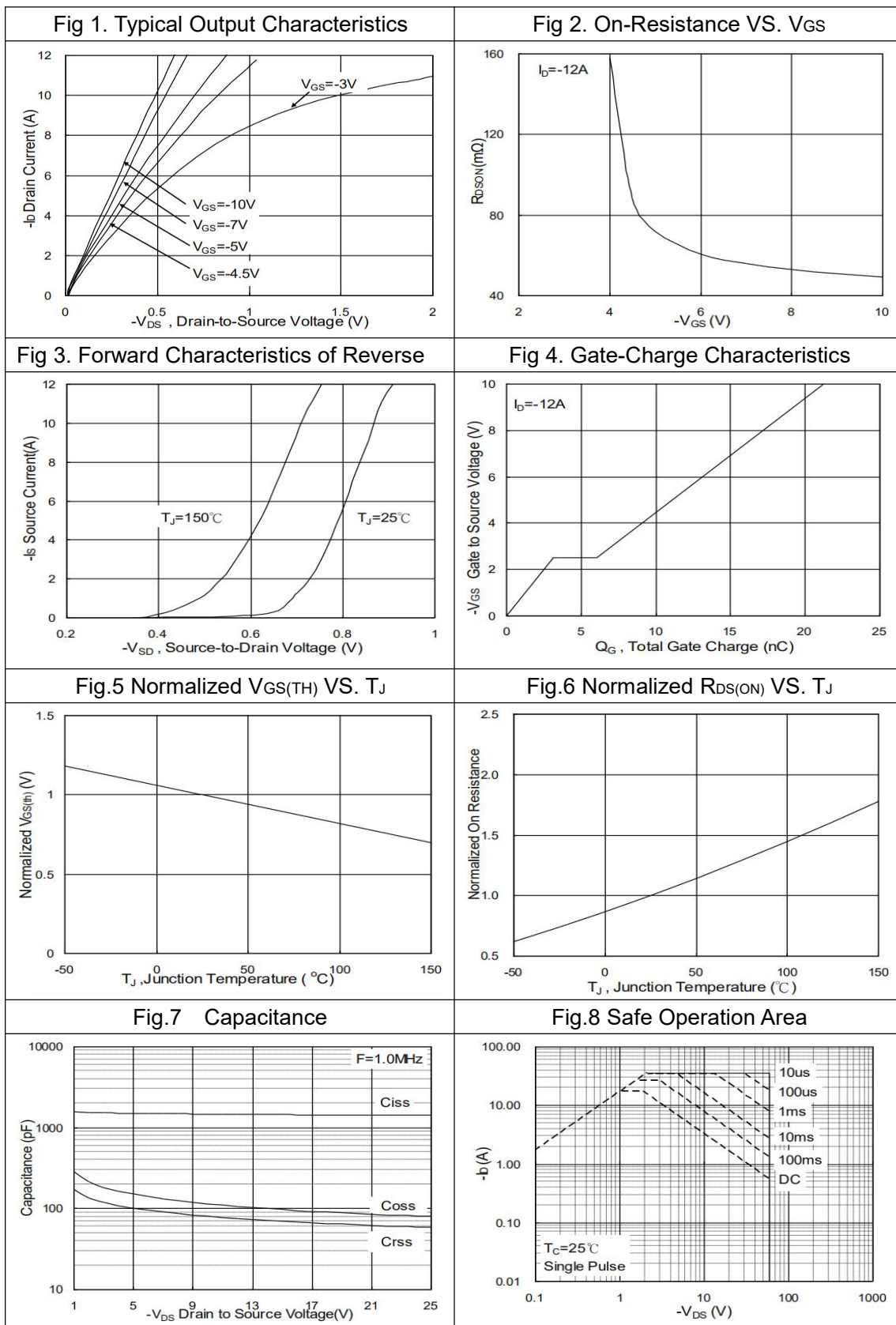
3.The EAS data shows Max. rating . The test condition is $V_{DD}=-25V, V_{GS}=-10V, L=0.1mH, I_{AS}=-26.6A$

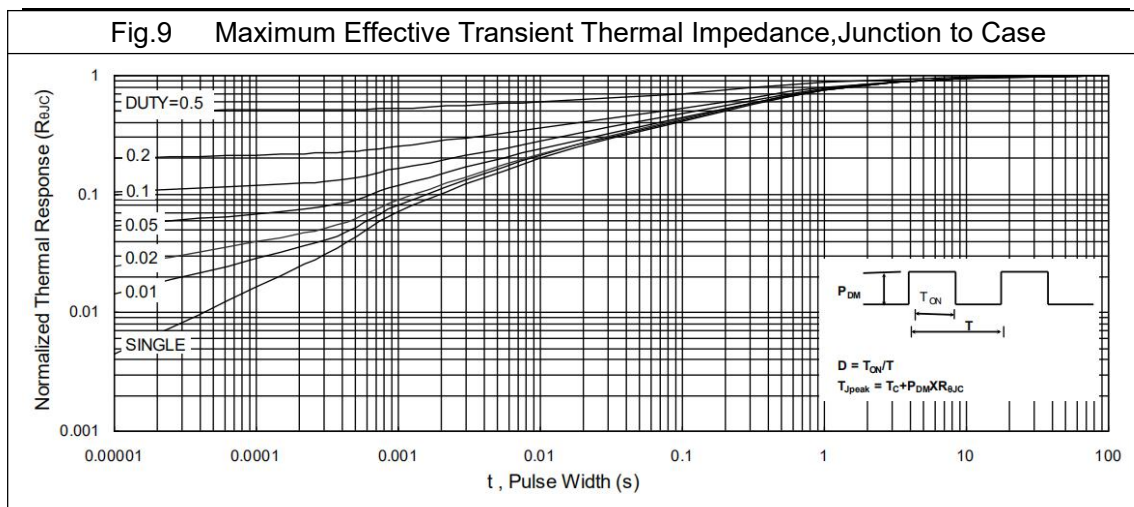
4.The power dissipation is limited by 150°C junction temperature

5.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.



TYPICAL CHARACTERISTICS

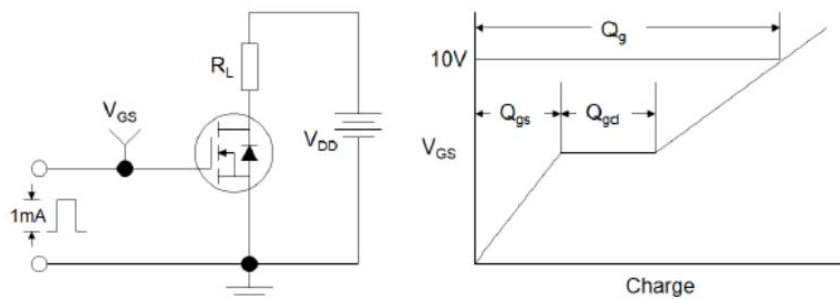




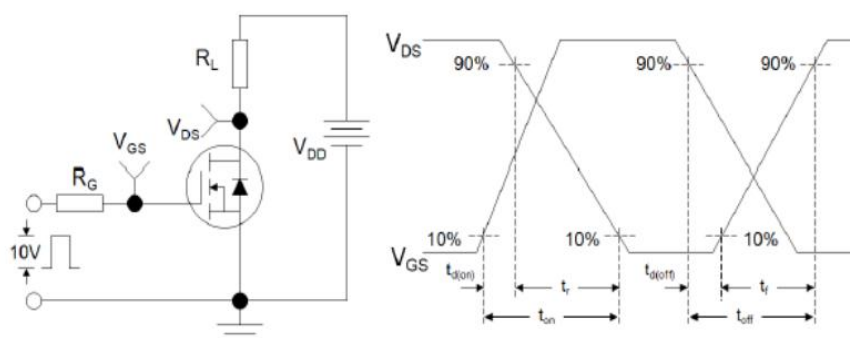


TEST CIRCUITS

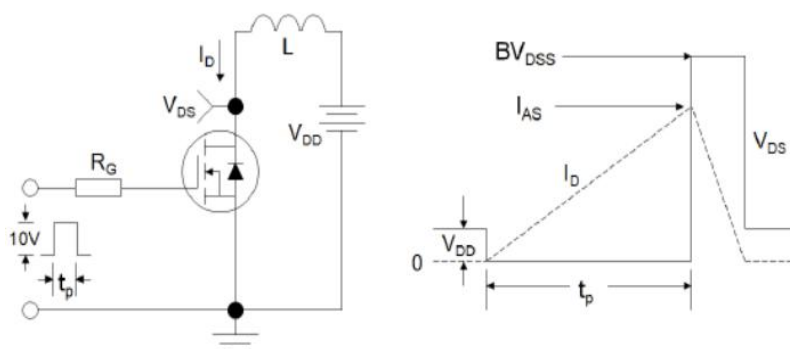
Gate Charge Test Circuit and Waveform



Resistive Switching Test Circuit and Waveform



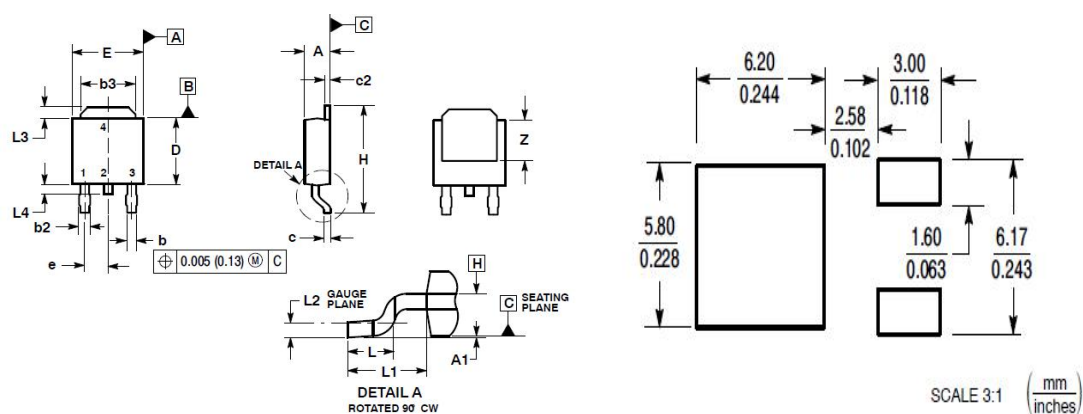
Unclamped Inductive Switching Test Circuit and Waveform





PACKAGE DIMENSIONS

TO-252



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.086	0.094	2.18	2.38
A1	0.000	0.005	0.00	0.13
b	0.025	0.035	0.63	0.89
b2	0.030	0.045	0.76	1.14
b3	0.180	0.215	4.57	5.46
c	0.018	0.024	0.46	0.61
c2	0.018	0.024	0.46	0.61
D	0.235	0.245	5.97	6.22
E	0.250	0.265	6.35	6.73
e	0.090 BSC		2.29 BSC	
H	0.370	0.410	9.40	10.41
L	0.055	0.070	1.40	1.78
L1	0.108 REF		2.74 REF	
L2	0.020 BSC		0.51 BSC	
L3	0.035	0.050	0.89	1.27
L4	---	0.040	---	1.01
Z	0.155	---	3.93	---